

DR-BT22

SERVICE MANUAL

Ver. 1.0 2007. 07

*US Model
Canadian Model
AEP Model
UK Model
E Model
Australian Model*



SPECIFICATIONS

General

Communication System

Bluetooth Specification version 2.0

Output

Bluetooth Specification Power Class 2

Maximum communication range

Line of sight approx. 10 m (30 ft) ^{*1}

Frequency band

2.4 GHz band (2.4000 GHz – 2.4835 GHz)

Modulation method

FHSS

Compatible Bluetooth Profiles^{*2}

A2DP (Advanced Audio Distribution Profile)

AVRCP (Audio Video Remote Control Profile)

HSP (Headset Profile)

HFP (Hands-free Profile)

Supported Codecs^{*3}

SBC^{*4}, MP3

Supported content protection method

SCMS-T

Transmission range (A2DP)

20 - 20,000 Hz (Sampling frequency 44.1 kHz)

Supplied accessory

AC power adaptor (1)

Operating instruction (1)

Headset

Power source

DC 3.7 V: Built-in lithium-ion rechargeable battery

Mass

Approx. 78 g (2.8 oz)

Rated power consumption

1.5 W

Receiver

Type

Open air, dynamic

Driver unit

30 mm dome type

Reproduction frequency range

14 – 24,000 Hz

Microphone

Type

Omni directional, electret condenser

Effective frequency range

100 – 4,000 Hz

Design and specifications are subject to change without notice.

^{*1} The actual range will vary depending on factors such as obstacles between devices, magnetic fields around a microwave oven, static electricity, reception sensitivity, aerial's performance, operating system, software application, etc.

^{*2} Bluetooth standard profiles indicate the purpose of Bluetooth communication between devices.

^{*3} Codec: Audio signal compression and conversion format

^{*4} Subband Codec

WIRELESS STEREO HEADSET

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Notes on Chip Component Replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

CAUTION
 Danger of explosion if battery is incorrectly replaced.
 Replace only with the same or equivalent type.

● **UNLEADED SOLDER**

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead.

(Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40°C higher than ordinary solder.

Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.

Soldering irons using a temperature regulator should be set to about 350°C.

Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!

- Strong viscosity
 Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.

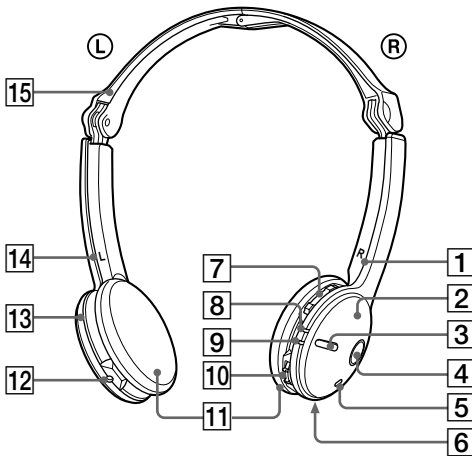
- Usable with ordinary solder
 It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

- IC101 (CXN1450-2ABL) on MAIN board cannot be replaced individually.
 Replace it with “MAIN BOARD, COMPLETE”.

**SECTION 1
 GENERAL**

This section is extracted from instruction manual.

Location and Function of Parts

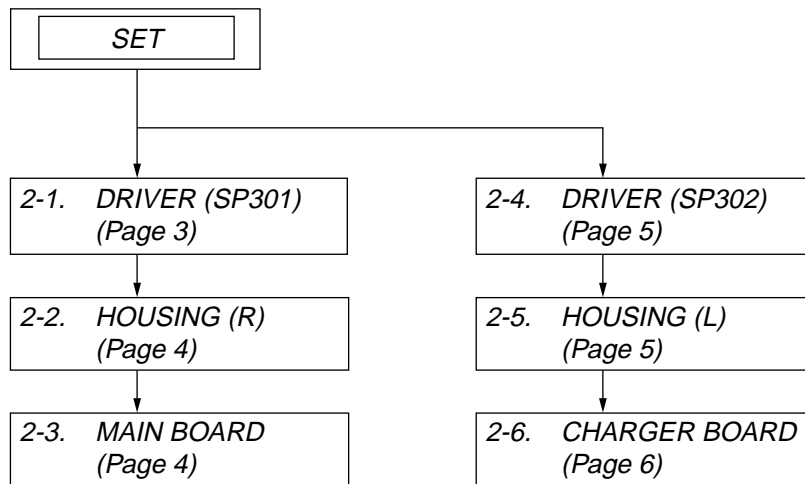


- 1** **® (right) indication**
- 2** **Right (®) unit**
- 3** **Multi function button**
Controls various call functions.
- 4** **POWER button**
- 5** **Microphone**
- 6** **RESET button**
Push this button when this unit does not operate properly. Pairing information is not deleted by this operation.
- 7** **VOL (volume) +*/- buttons**
- 8** **Indicator (blue)**
Indicates the communication status of the unit.
- 9** **Indicator (red)**
Indicates the power status of the unit.
- 10** **Jog switch**
Controls various functions when listening to music.
- 11** **Ear pad**
- 12** **DC IN 3 V jack**
- 13** **Left (Ⓛ) unit**
- 14** **Ⓛ (left) indication**
- 15** **Headband**

* This button has a tactile dot.

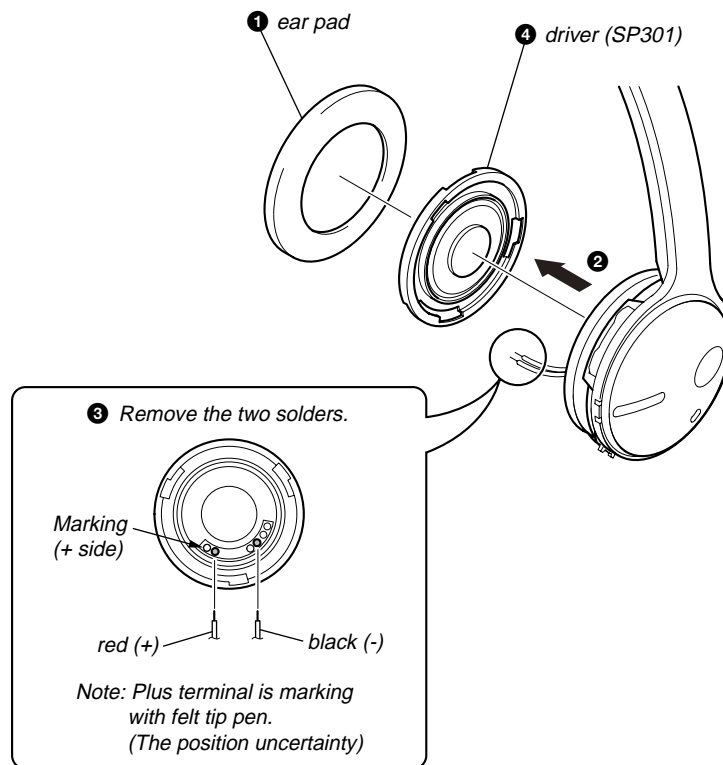
SECTION 2 DISASSEMBLY

Note: This set can be disassemble according to the following sequence.

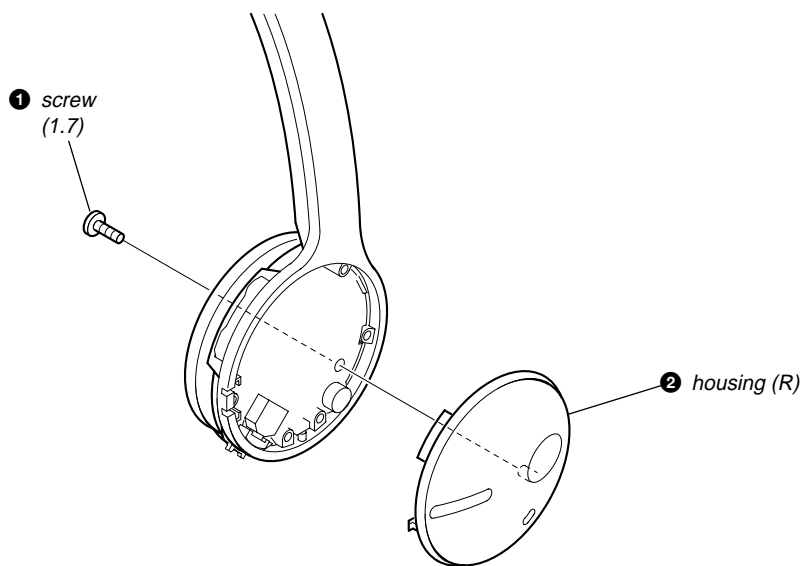


Note: Follow the disassembly procedure in the numerical order given.

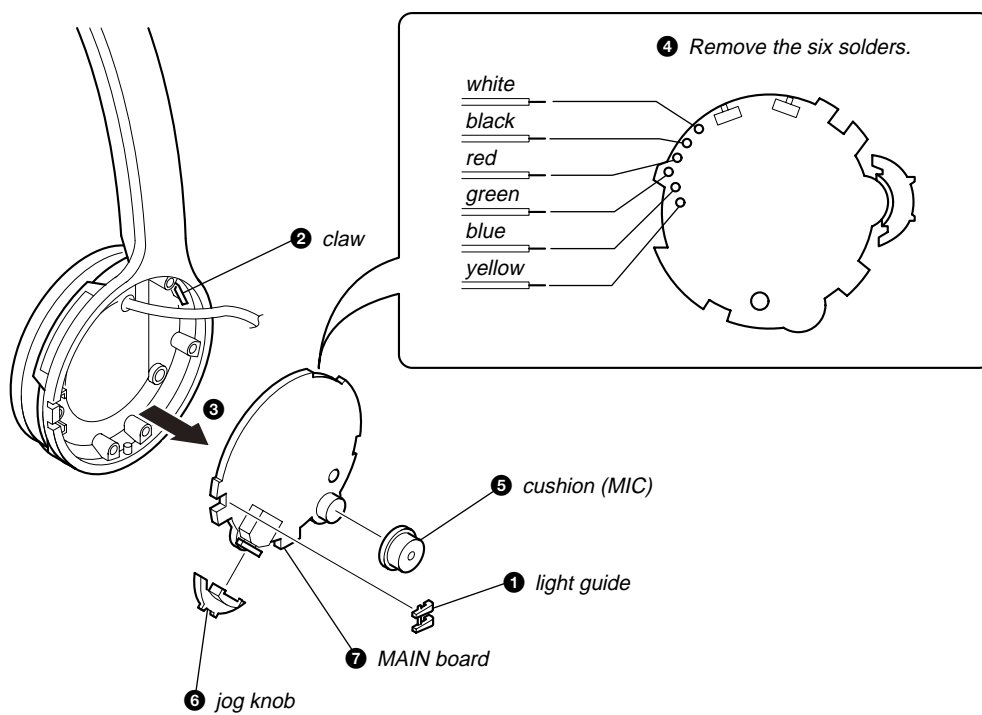
2-1. DRIVER (SP301)



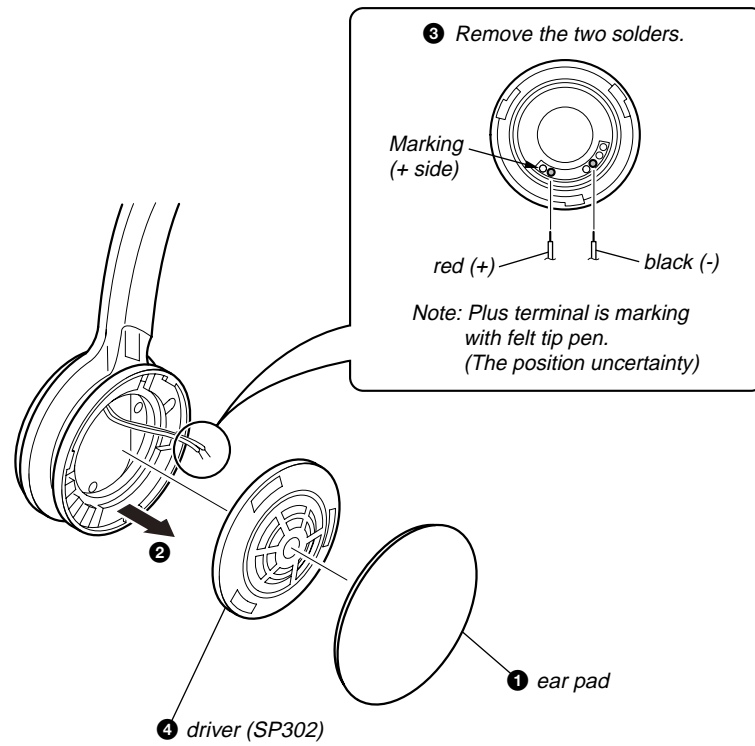
2-2. HOUSING (R)



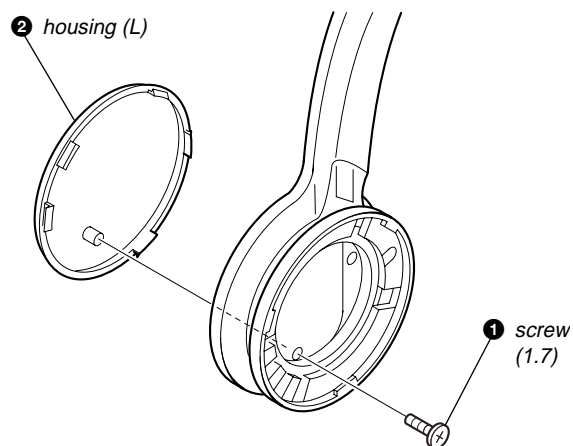
2-3. MAIN BOARD



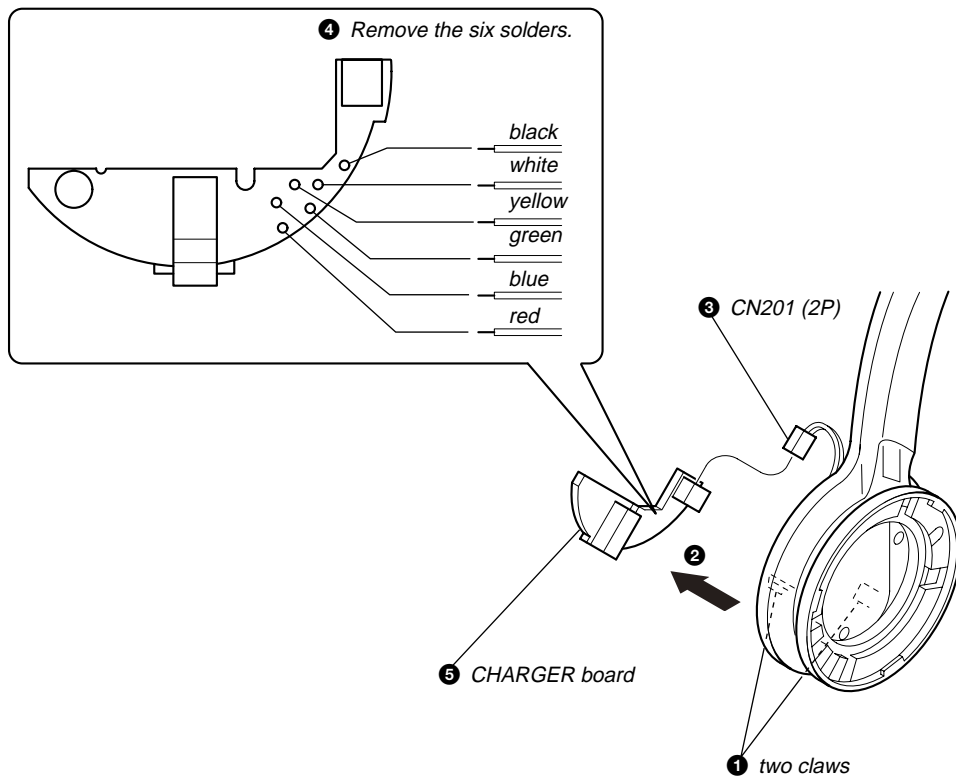
2-4. DRIVER (SP302)



2-5. HOUSING (L)



2-6. CHARGER BOARD



SECTION 3 DIAGRAMS

THIS NOTE IS COMMON FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS.
(In addition to this, the necessary note is printed in each block.)

for schematic diagram:

- Note:**
- All capacitors are in μF unless otherwise noted. (p: pF) 50 WV or less are not indicated except for electrolytics and tantalums.
 - All resistors are in Ω and $1/4\text{W}$ or less unless otherwise specified.
 - % : indicates tolerance.
 - : panel designation.
 - : B+ Line.
 - Power voltage are dc 3.7 V and fed with regulated dc power supply from battery terminal.
 - Voltages are dc with respect to ground under tolerances. no mark : STANDBY () : AC ADAPTOR IN
 - Voltages are taken with a VOM (Input impedance 10 M Ω). Voltage variations may be noted due to normal production tolerances.
 - Signal path. \Rightarrow : AUDIO
 - IC101 (CXN1450-2ABL) on MAIN board cannot be replaced individually. Replace it with "MAIN BOARD, COMPLETE".
 - The voltage of IC101 cannot be measured.

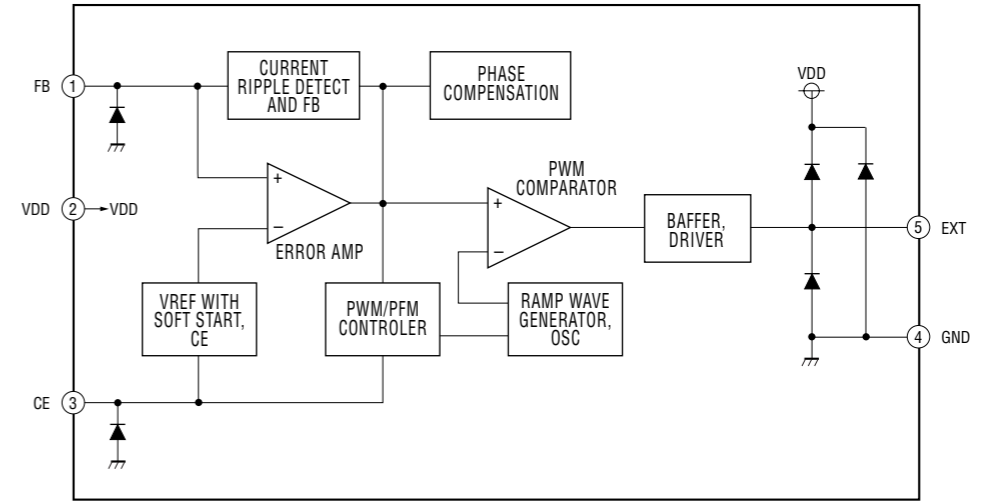
for printed wiring boards:

- Note:**
- : parts extracted from the component side.
 - : parts extracted from the conductor side.
 - : Pattern from the side which enables seeing. (The other layers' patterns are not indicated.)
- Caution:**
Parts face side: Parts on the parts face side seen from the parts face are indicated.
Pattern face side: Parts on the pattern face side seen from the pattern face are indicated.
- MAIN board is four-layer printed board. However, the patterns of layer 2 and 3 have not been included in this diagrams.

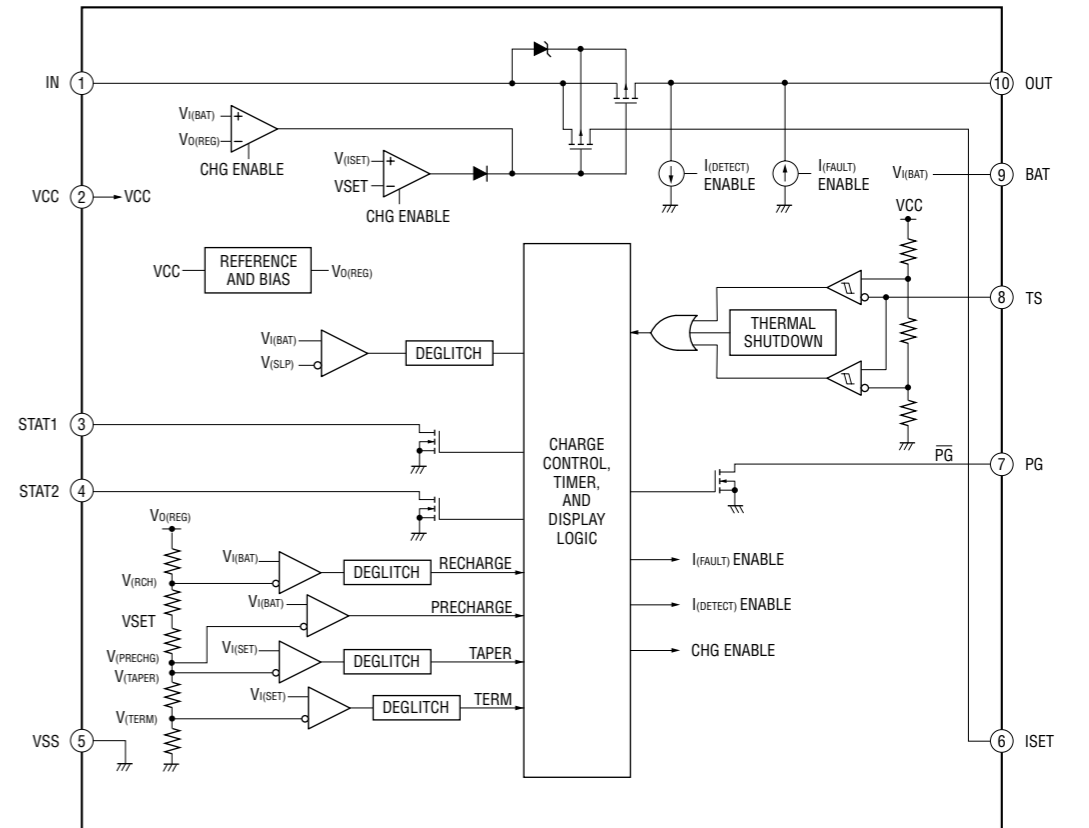
• IC Block Diagrams

— CHARGER Board —

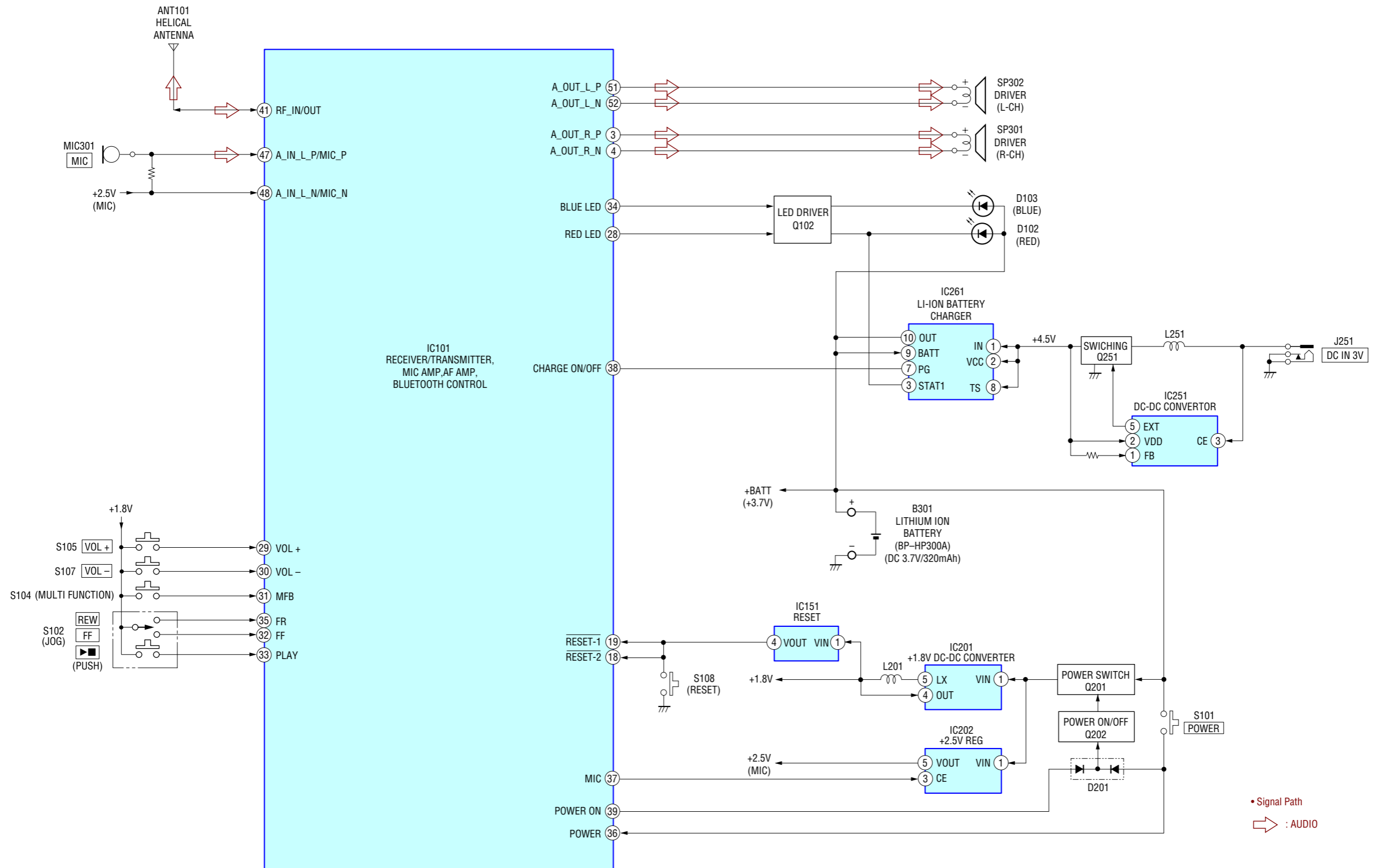
IC251 XC9103D093MR



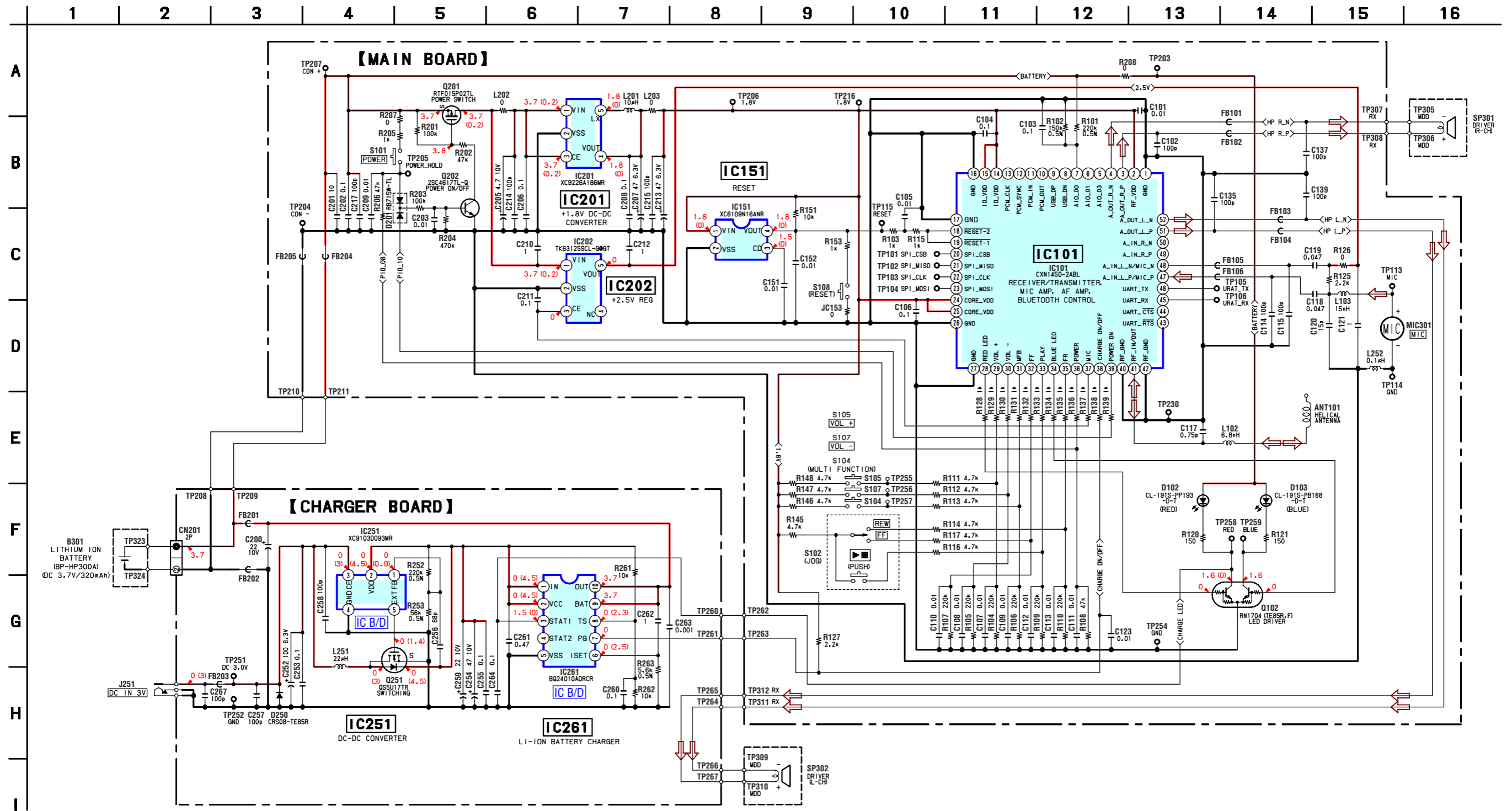
IC261 BQ24010ADRCR



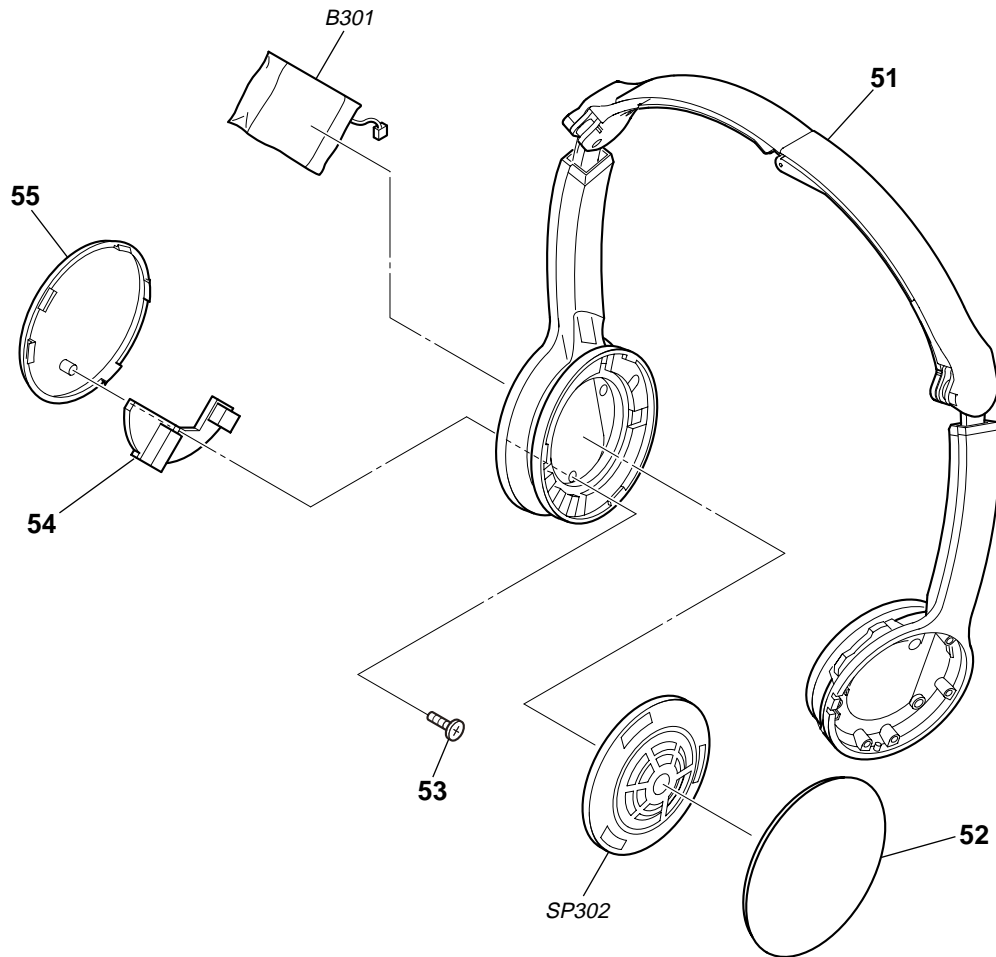
3-1. BLOCK DIAGRAM



3-3. SCHEMATIC DIAGRAM • Refer to page 7 for IC Block Diagrams.



4-2. HOUSING (L) SECTION



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
51	X-2187-558-1	HEAD BAND ASSY		55	3-209-791-01	HOUSING (L)	
52	4-994-324-01	PAD, EAR		B301	X-2184-559-1	LITHIUM ION BATTERY SUB ASSY (BP-HP300A) (DC 3.7V/320mAh)	
53	3-252-825-01	SCREW (1.7)		SP302	1-542-653-21	DRIVER (030F041Q) (L-CH)	
54	A-1308-884-A	CHARGER BOARD, COMPLETE					

MAIN

Ref. No.	Part No.	Description	Remark
C206	1-125-777-11	CERAMIC CHIP 0.1uF 10%	10V
C207	1-100-539-11	TANTAL. CHIP 47uF 20%	6.3V
C208	1-125-777-11	CERAMIC CHIP 0.1uF 10%	10V
C209	1-164-943-81	CERAMIC CHIP 0.01uF 10%	16V
C210	1-100-506-11	CERAMIC CHIP 1uF 20%	6.3V
C211	1-125-777-11	CERAMIC CHIP 0.1uF 10%	10V
C212	1-100-506-11	CERAMIC CHIP 1uF 20%	6.3V
C213	1-100-539-11	TANTAL. CHIP 47uF 20%	6.3V
C214	1-164-874-11	CERAMIC CHIP 100PF 5%	50V
C215	1-164-874-11	CERAMIC CHIP 100PF 5%	50V
C217	1-164-874-11	CERAMIC CHIP 100PF 5%	50V
< DIODE >			
D102	6-501-537-01	LED CL-191S-PP193-D-T (RED)	
D103	6-501-538-01	LED CL-191S-PB168-D-T (BLUE)	
D201	8-719-082-45	DIODE RB715W-TL	
< FERRITE BEAD >			
FB101	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB102	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB103	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB104	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB105	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB106	1-469-084-21	INDUCTOR, FERRITE BEAD	
FB204	1-400-050-11	INDUCTOR, FERRITE BEAD	
FB205	1-400-050-11	INDUCTOR, FERRITE BEAD	
< IC >			
IC101	(Not supplied)	IC CXN1450-2ABL	
IC151	6-709-935-01	IC XC6109N16ANR	
IC201	6-709-718-01	IC XC9226A186MR	
IC202	6-711-211-01	IC TK63125SCL-G@GT	
< JUMPER RESISTOR >			
JC153	1-218-990-81	SHORT CHIP 0	
< COIL >			
L102	1-481-261-11	INDUCTOR 6.8nH	
L103	1-414-842-21	INDUCTOR 15nH	
L201	1-481-035-11	INDUCTOR 10uH	
L202	1-218-990-81	SHORT CHIP 0	
L203	1-218-990-81	SHORT CHIP 0	
L252	1-412-967-31	INDUCTOR 0.1uH	
< TRANSISTOR >			
Q102	6-550-974-01	TRANSISTOR RN1704(TE85R.F)	
Q201	6-551-067-01	FET RTF015P02TL	
Q202	8-729-927-99	TRANSISTOR 2SC4617R	
< RESISTOR >			
R101	1-208-943-11	METAL CHIP 220K 0.5%	1/16W
R102	1-208-939-11	METAL CHIP 150K 0.5%	1/16W
R103	1-218-953-11	RES-CHIP 1K 5%	1/16W
R104	1-218-981-11	RES-CHIP 220K 5%	1/16W
R105	1-218-981-11	RES-CHIP 220K 5%	1/16W
R106	1-218-981-11	RES-CHIP 220K 5%	1/16W
R107	1-218-981-11	RES-CHIP 220K 5%	1/16W

Ref. No.	Part No.	Description	Remark
R108	1-218-973-11	RES-CHIP 47K 5%	1/16W
R109	1-218-981-11	RES-CHIP 220K 5%	1/16W
R110	1-218-981-11	RES-CHIP 220K 5%	1/16W
R111	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R112	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R113	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R114	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R115	1-218-953-11	RES-CHIP 1K 5%	1/16W
R116	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R117	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R120	1-218-943-11	RES-CHIP 150 5%	1/16W
R121	1-218-943-11	RES-CHIP 150 5%	1/16W
R125	1-218-957-11	RES-CHIP 2.2K 5%	1/16W
R126	1-218-990-81	SHORT CHIP 0	
R127	1-218-957-11	RES-CHIP 2.2K 5%	1/16W
R128	1-218-953-11	RES-CHIP 1K 5%	1/16W
R129	1-218-953-11	RES-CHIP 1K 5%	1/16W
R130	1-218-953-11	RES-CHIP 1K 5%	1/16W
R131	1-218-953-11	RES-CHIP 1K 5%	1/16W
R132	1-218-953-11	RES-CHIP 1K 5%	1/16W
R133	1-218-953-11	RES-CHIP 1K 5%	1/16W
R134	1-218-953-11	RES-CHIP 1K 5%	1/16W
R135	1-218-953-11	RES-CHIP 1K 5%	1/16W
R136	1-218-953-11	RES-CHIP 1K 5%	1/16W
R137	1-218-953-11	RES-CHIP 1K 5%	1/16W
R138	1-218-953-11	RES-CHIP 1K 5%	1/16W
R139	1-218-953-11	RES-CHIP 1K 5%	1/16W
R145	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R146	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R147	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R148	1-218-961-11	RES-CHIP 4.7K 5%	1/16W
R151	1-218-965-11	RES-CHIP 10K 5%	1/16W
R153	1-218-953-11	RES-CHIP 1K 5%	1/16W
R201	1-218-977-11	RES-CHIP 100K 5%	1/16W
R202	1-218-973-11	RES-CHIP 47K 5%	1/16W
R203	1-218-977-11	RES-CHIP 100K 5%	1/16W
R204	1-218-985-11	RES-CHIP 470K 5%	1/16W
R205	1-218-953-11	RES-CHIP 1K 5%	1/16W
R206	1-218-973-11	RES-CHIP 47K 5%	1/16W
R207	1-218-990-81	SHORT CHIP 0	
R208	1-218-990-81	SHORT CHIP 0	
< SWITCH >			
S101	1-771-844-21	SWITCH, TACTILE (SMD) (POWER)	
S102	1-798-088-11	SWITCH, LEVER (SLIDE) (JOG)	
S104	1-771-844-21	SWITCH, TACTILE (SMD) (MULTI FUNCTION)	
S105	1-786-722-21	SWITCH, TACTILE (VOL +)	
S107	1-786-722-21	SWITCH, TACTILE (VOL -)	
S108	1-786-722-21	SWITCH, TACTILE (RESET)	

• IC101 (CXN1450-2ABL) on MAIN board cannot be replaced individually.
Replace it with "MAIN BOARD, COMPLETE".

<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>
		MISCELLANEOUS *****	
B301	X-2184-559-1	LITHIUM ION BATTERY SUB ASSY (BP-HP300A) (DC 3.7V/320mAh)	
MIC301	1-542-707-11	MICROPHONE, ELECTRET CONDENSER (MIC)	
SP301	1-542-653-21	DRIVER (030F041Q) (R-CH)	
SP302	1-542-653-21	DRIVER (030F041Q) (L-CH)	

		ACCESSORIES *****	
△	1-478-846-12	ADAPTOR, AC (AC-ES3010K2) (US,CND)	
△	1-478-847-11	ADAPTOR, AC (AC-ES3010K2) (KR)	
△	1-478-848-13	ADAPTOR, AC (AC-ES3010K2) (AEP,E13)	
△	1-478-849-12	ADAPTOR, AC (AC-ES3010K2) (UK)	
△	1-478-850-11	ADAPTOR, AC (AC-ES3010K2) (AUS)	
	3-268-834-11	MANUAL, INSTRUCTION (ENGLISH) (AEP,UK)	
	3-268-834-21	MANUAL, INSTRUCTION (FRENCH,GERAN, SPANISH) (AEP)	
	3-268-834-31	MANUAL, INSTRUCTION (DUTCH,ITALIAN, PORTUGUESE,RUSSIAN) (AEP)	
	3-268-834-41	MANUAL, INSTRUCTION (SWEDISH, NORWEGIAN,FINNISH,DANISH) (AEP)	
	3-268-834-51	MANUAL, INSTRUCTION (ENGLISH,SPANISH) (US)	
	3-268-834-61	MANUAL, INSTRUCTION (ENGLISH,FRENCH) (CND)	
	3-268-834-71	MANUAL, INSTRUCTION (ENGLISH) (E13,AUS,KR)	
	3-268-834-81	MANUAL, INSTRUCTION (KOREAN) (KR)	
	3-268-834-91	MANUAL, INSTRUCTION (TRADITIONAL CHINESE) (UK)	

